



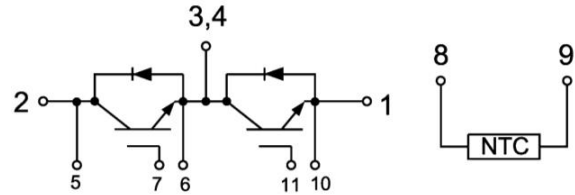
GT600HF120T9H

IGBT Module

Features:

- Trench & Field Stop IGBT
- Short Circuit Rated > 10 μ s
- Low Switching Loss
- 100% RBSOA Tested (2 \times I_c)
- Low Stray Inductance
- Lead Free, Compliant with RoHS Requirement

Circuit Diagram



Applications:

- Hybrid Electrical Vehicles (HEV)
- Automotive Applications
- Commercial Agriculture Vehicles
- Motor Drives

IGBT, Inverter Maximum Rated Values

V _{CES}	Collector-Emitter Blocking Voltage	T _J =25°C	1200	V
V _{GES}	Gate-Emitter Voltage		±20	V
I _C	Continuous Collector Current	T _C =100°C	600	A
		T _C =25°C	1200	A
I _{CM}	Peak Collector Current Repetitive	t _p =1ms	1200	A
t _{SC}	Short Circuit Withstand Time		>10	μs
P _D	Maximum Power Dissipation (IGBT)	T _C =25°C T _{Jmax} =150°C	2770	W



Electrical Characteristics of IGBT

Static Characteristics

Symbol	Description	Conditions	Min.	Typ.	Max.	Units
$V_{GE(th)}$	Gate-Emitter Threshold Voltage	$I_C=72mA, V_{CE}=V_{GE}, T_J=25^\circ C$	5.0	5.7	6.8	V
$V_{CE(sat)}$	Collector-Emitter Saturation Voltage	$I_C=600A, V_{GE}=15V$	$T_J=25^\circ C$	2.00	2.20	V
			$T_J=125^\circ C$	2.35		V
			$T_J=150^\circ C$	2.40		V
I_{CES}	Collector-Emitter Leakage Current	$V_{GE}=0V, V_{CE}=V_{CES}, T_J=25^\circ C$			1	mA
I_{GES}	Gate-Emitter Leakage Current	$V_{GE}=\pm 20V, V_{CE}=0V, T_J=25^\circ C$			600	nA
C_{ies}	Input Capacitance	$V_{CE}=25V, V_{GE}=0V, f=100kHz, T_J=25^\circ C$		86.8		nF
C_{oes}	Output Capacitance			3.49		nF
C_{res}	Reverse Transfer Capacitance			1.84		nF

Switching Characteristics

$t_{d(on)}$	Turn-on Delay Time	$V_{CC}=600V, I_C=600A, R_{Gon}=1\Omega, V_{GE}=\pm 15V, \text{Inductive Load}$	$T_J=25^\circ C$	997		ns
			$T_J=125^\circ C$	987		
			$T_J=150^\circ C$	982		
t_r	Rise Time	$V_{CC}=600V, I_C=600A, R_{Gon}=1\Omega, V_{GE}=\pm 15V, \text{Inductive Load}$	$T_J=25^\circ C$	307		ns
			$T_J=125^\circ C$	313		
			$T_J=150^\circ C$	306		
$t_{d(off)}$	Turn-off Delay Time	$V_{CC}=600V, I_C=600A, R_{Goff}=1\Omega, V_{GE}=\pm 15V, \text{Inductive Load}$	$T_J=25^\circ C$	851		ns
			$T_J=125^\circ C$	898		
			$T_J=150^\circ C$	894		
t_f	Fall Time	$V_{CC}=600V, I_C=600A, R_{Goff}=1\Omega, V_{GE}=\pm 15V, \text{Inductive Load}$	$T_J=25^\circ C$	168		ns
			$T_J=125^\circ C$	198		
			$T_J=150^\circ C$	200		
E_{on}	Turn-on Switching Loss	$V_{CC}=600V, I_C=600A, R_{Gon}=1\Omega, V_{GE}=\pm 15V, di/dt=1640A/\mu s (T_J=150^\circ C) \text{ Inductive Load}$	$T_J=25^\circ C$	53.2		mJ
			$T_J=125^\circ C$	75.9		
			$T_J=150^\circ C$	78.9		



E _{off}	Turn-off Switching Loss	V _{CC} =600V, I _C =600A, R _{Goff} =1Ω, V _{GE} = ±15V, du/dt=3600V/μs (T _J =150°C) Inductive Load	T _J =25°C	82.1	mJ
			T _J =125°C	91.8	
			T _J =150°C	95.3	
Q _g	Total Gate Charge	V _{GE} =+15V...-15V	T _J =25°C	5.89	μC
R _{g internal}	Internal Gate Resistance		T _J =25°C	0	Ω
RBSOA	I _C =1200A, V _{CC} =1050V, V _p =1200V, R _G =1Ω, V _{GE} =+15V to 0V, T _J =125°C			Trapezoid	
I _{SC}	V _{CC} =600V, V _{GE} =±15V, R _{Gon} =1Ω, R _{Goff} =1Ω, t _p =10us, T _J =125°C, Inductive Load			4180	A
R _{θJC}	IGBT Thermal Resistance: Junction-to-Case(per IGBT)			0.045	°C/W

Diode, Inverter Maximum Rated Values of Diode

V _{RRM}	Repetitive Peak Reverse Voltage	T _J =25°C	1200	V
I _F	Diode Continuous Forward Current		600	A
I _{FM}	Diode Maximum Forward Current	t _p =1ms	1200	A
I ² t	I ² t - Value	V _R =0V, t _p =10ms, T _J =125°C	40000	A ² s
		V _R =0V, t _p =10ms, T _J =150°C	37500	A ² s

Electrical Characteristics of Diode

Symbol	Description	Conditions	Min.	Typ.	Max.	Units
V _{FM}	Forward Voltage	I _F =600A	T _J =25°C	2.30	2.60	V
			T _J =125°C	2.45		
			T _J =150°C	2.45		
t _{rr}	Reverse Recovery Time	I _F =600A, -diF/dt=1840A/μs(T _J =150°C), V _R =600V, V _{GE} =-15V	T _J =25°C	246		ns
			T _J =125°C	367		
			T _J =150°C	403		
I _{rr}	Peak Reverse Recovery Current	V _R =600V, V _{GE} =-15V	T _J =25°C	169		A
			T _J =125°C	238		
			T _J =150°C	263		



Q _{rr}	Reverse Recovery Charge	I _F =600A, -diF/dt=1840A/μs(T _J =150°C), V _R =600V, V _{GE} =-15V	T _J =25°C	25.5	μC
			T _J =125°C	55.8	
			T _J =150°C	65.2	
E _{rec}	Reverse Recovery Energy		T _J =25°C	9.78	mJ
			T _J =125°C	20.9	
			T _J =150°C	25.8	
R _{θJC}	Diode Thermal Resistance: Junction-to-Case (per Diode)			0.064	°C/W

Internal NTC-Thermistor Characteristics

Symbol	Description		Min.	Typ.	Max.	Units.
R ₂₅	Rated Resistance	T _C =25°C		5		kΩ
ΔR/R	Deviation of R100	T _C =100°C, R ₁₀₀ =481Ω	-5		5	%
P ₂₅	Power Dissipation	T _C =25°C			10	mW
B _{25/50}	B-Value	$R_2=R_{25} \exp[B_{25/50}(1/T_2-1/(298.15K))]$		3380		K
B _{25/80}	B-Value	$R_2=R_{25} \exp[B_{25/80}(1/T_2-1/(298.15K))]$		3440		K

Module

Symbol	Description		Min.	Typ.	Max.	Units
V _{iso}	Isolation Voltage (All Terminals Shorted)	RMS, f=50Hz, 1minute	2500			V
L _{sCE}	Stray Inductance Module			20		nH
T _J	Maximum Junction Temperature				150	°C
T _{JOP}	Maximum Operating Junction Temperature Range		-40		+150	°C
T _{stg}	Storage Temperature		-40		+125	°C
CTI	Comparative Tracking Index		200			
R _{θCS}	Case-to-Sink Thermally (Conductive Grease Applied)				0.02	°C/W
M	Terminals Connection Torque	Screw M6-Mounting according to valid application note	3.0		6.0	N·m
M	Mounting Torque for Module Mounting	Screw M5--Mounting according to valid application note	3.0		6.0	N·m
G	Weight			330		g



Ordering Information Table

Device code	G	T	600	HF	120	T9	H
	①	②	③	④	⑤	⑥	⑦

- ① - IGBT Module
- ② - Field Stop Trench Gate IGBT
- ③ - Rated Current (600=600A)
- ④ - Circuit Configuration (HF=Half Bridge)
- ⑤ - Rated Voltage (120=1200V)
- ⑥ - Package Type
- ⑦ - Test Level (Pass the Important Reliability Test-Industrial Grade)

DATA SHEET

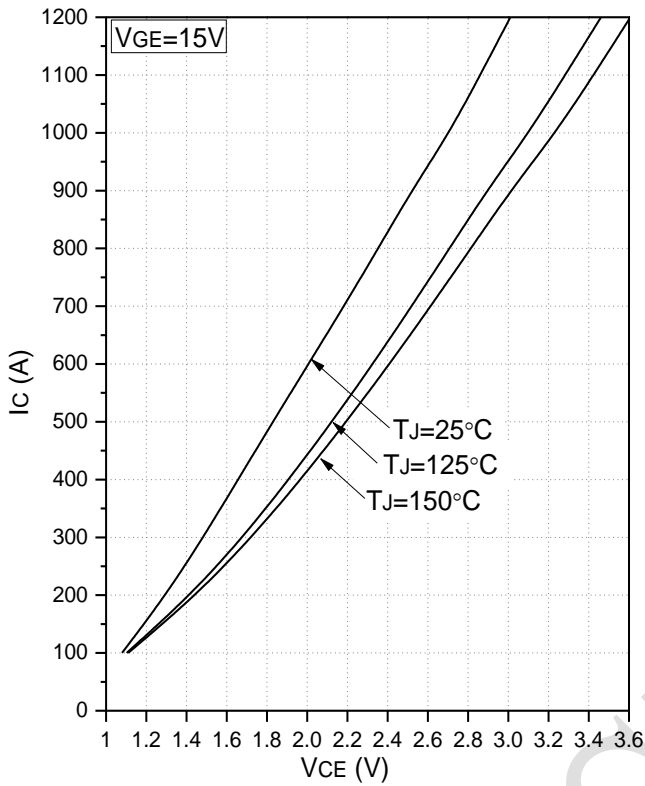


Fig.1 Typical Saturation Voltage Characteristics

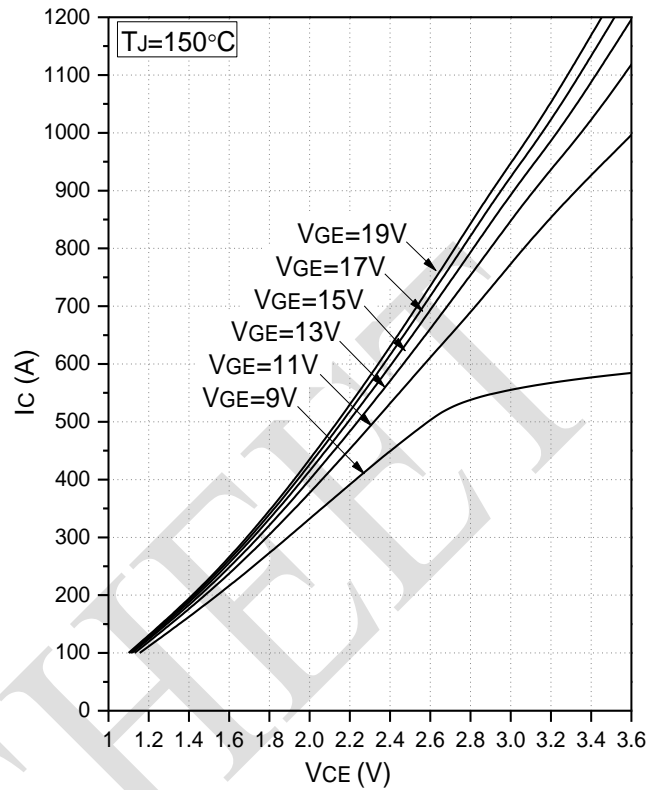


Fig.2 Typical Output Characteristics

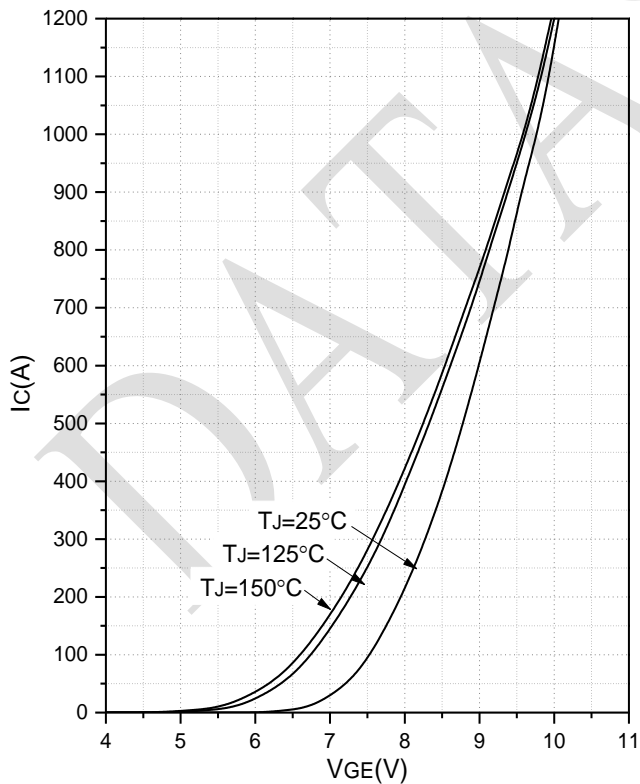


Fig.3 Transfer Characteristic

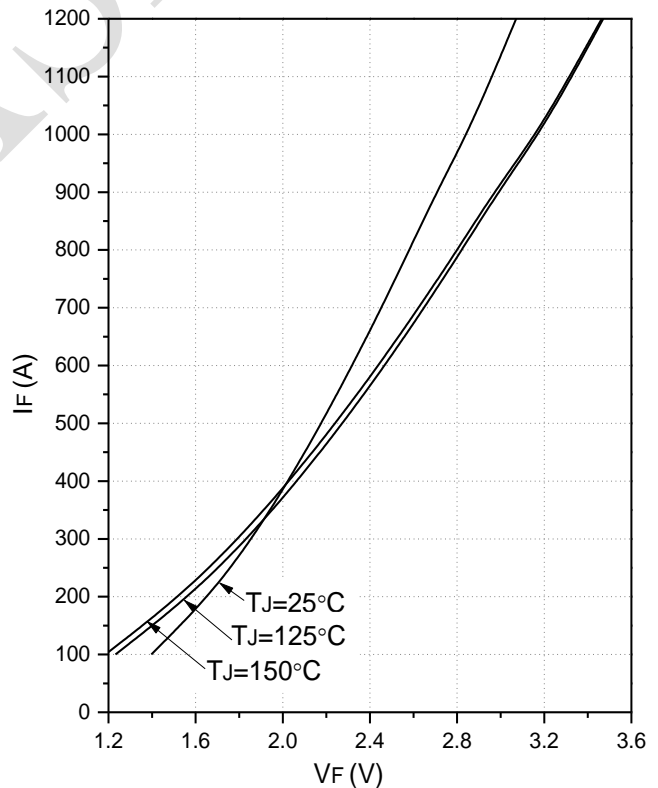


Fig.4 Forward Characteristics of Diode

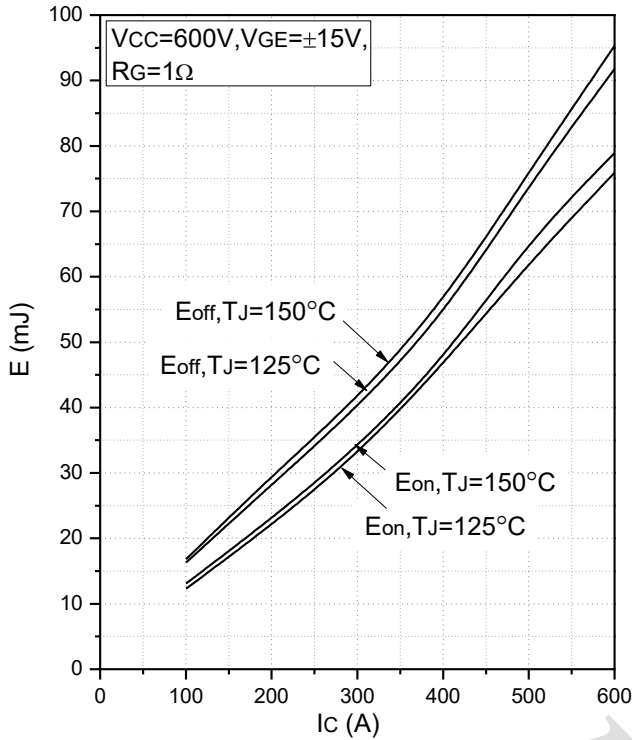


Fig.5 Typical Switching Loss vs. Collector Current

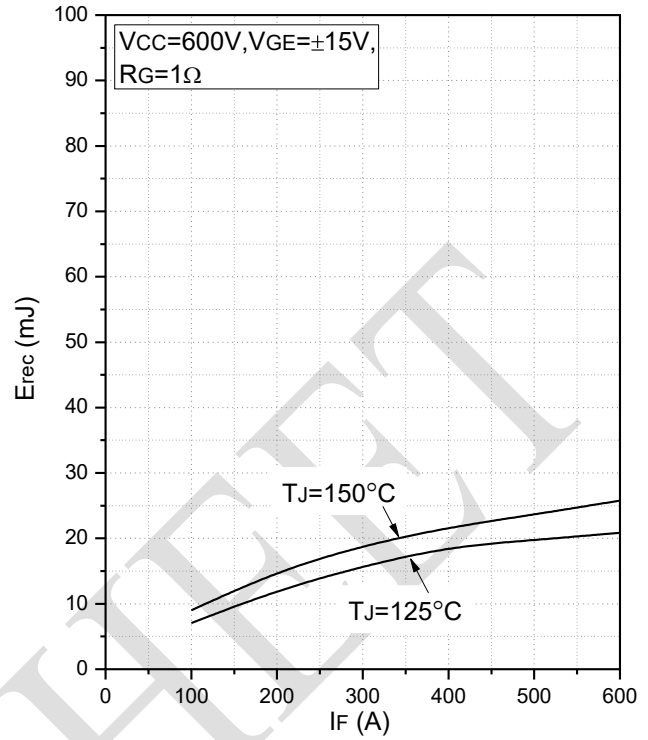


Fig.6 Typical Switching Loss vs. Forward Current

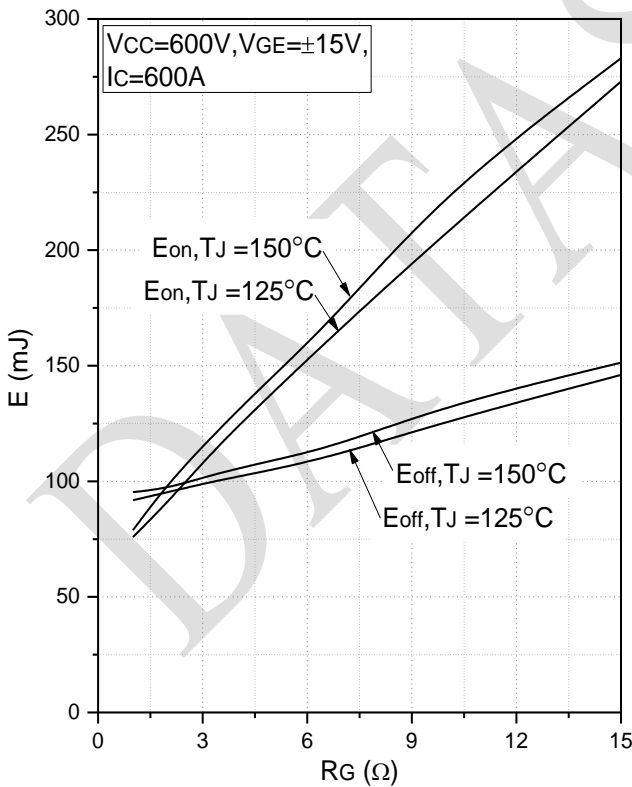


Fig.7 Typical Switching Loss vs. Gate Resistance

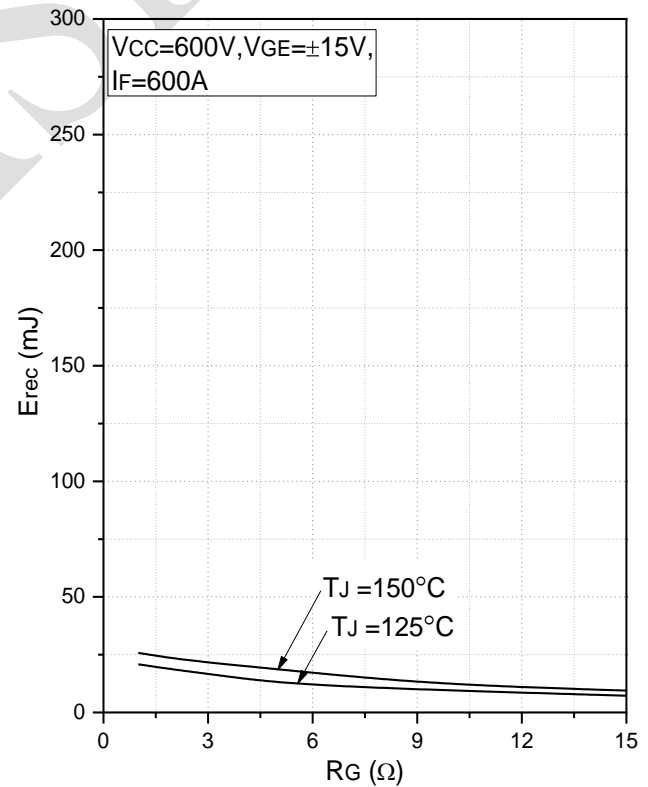
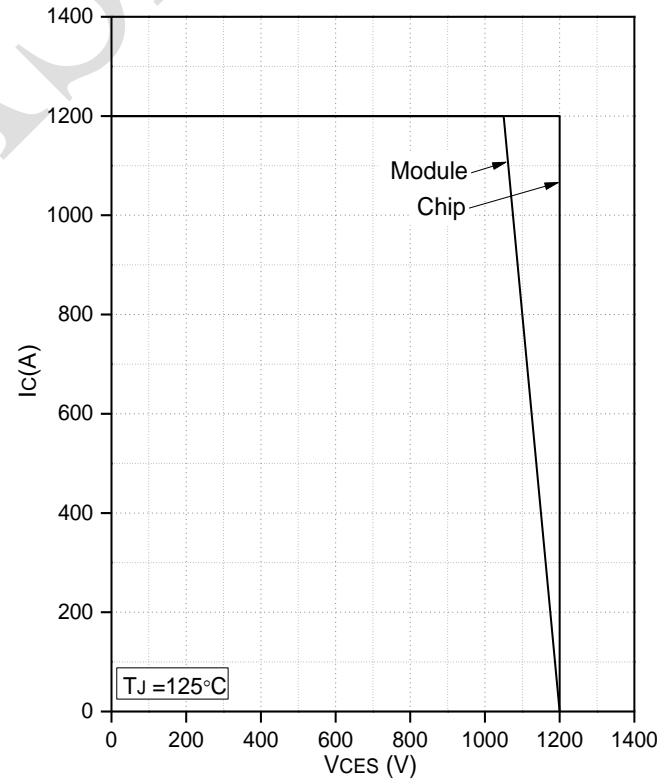
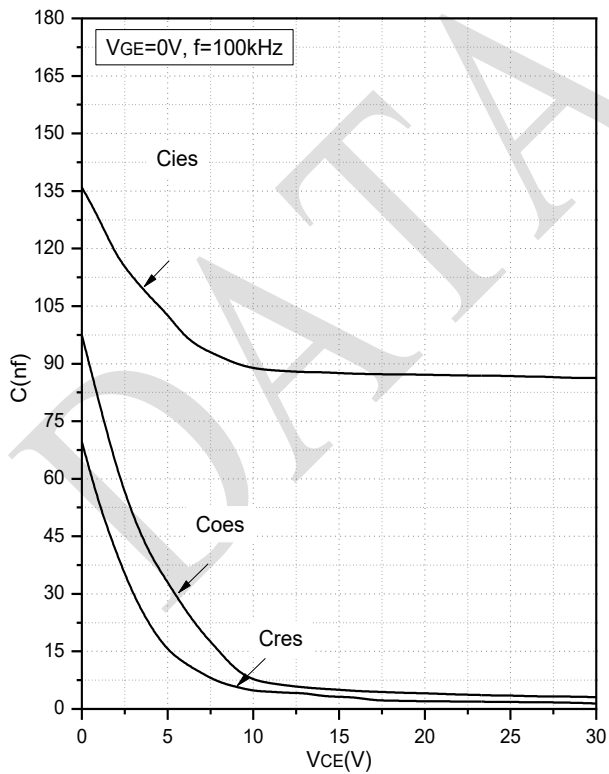
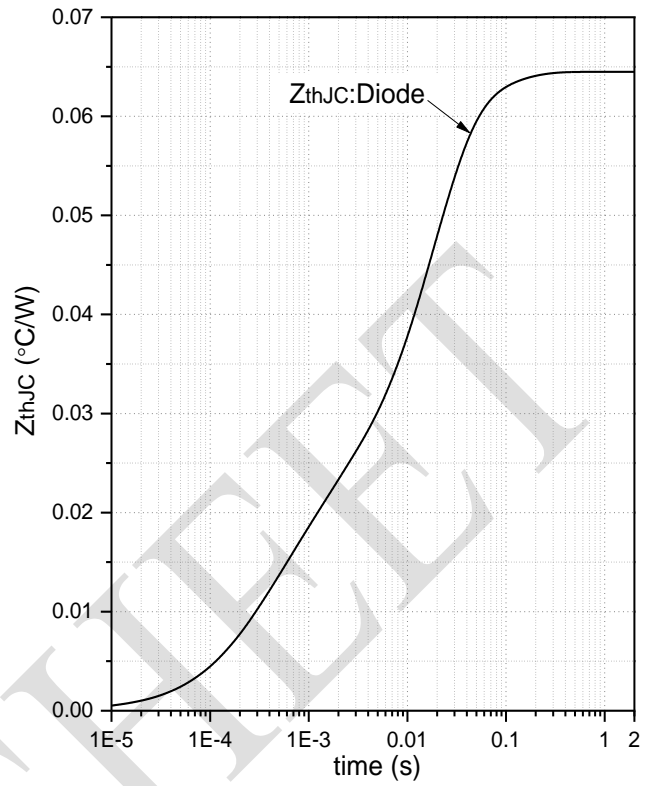
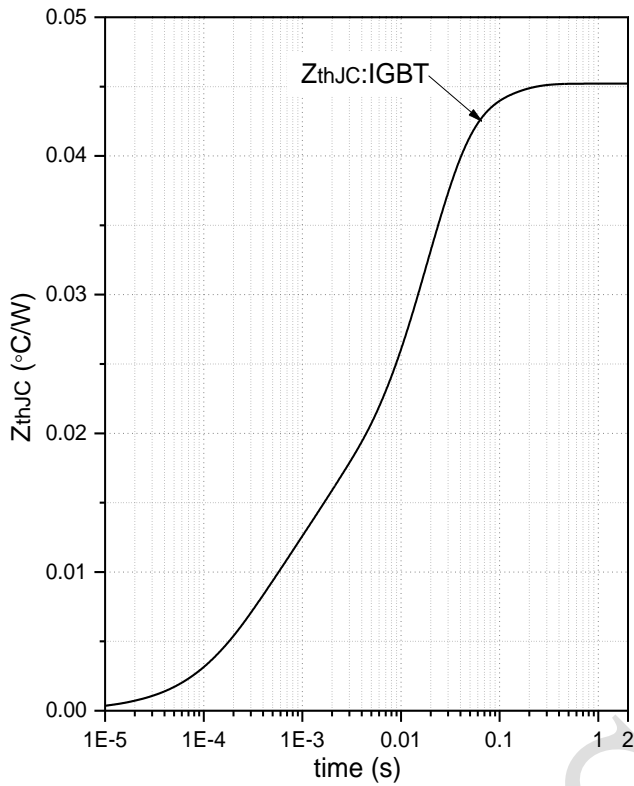


Fig.8 Typical Switching Loss vs. Gate Resistance



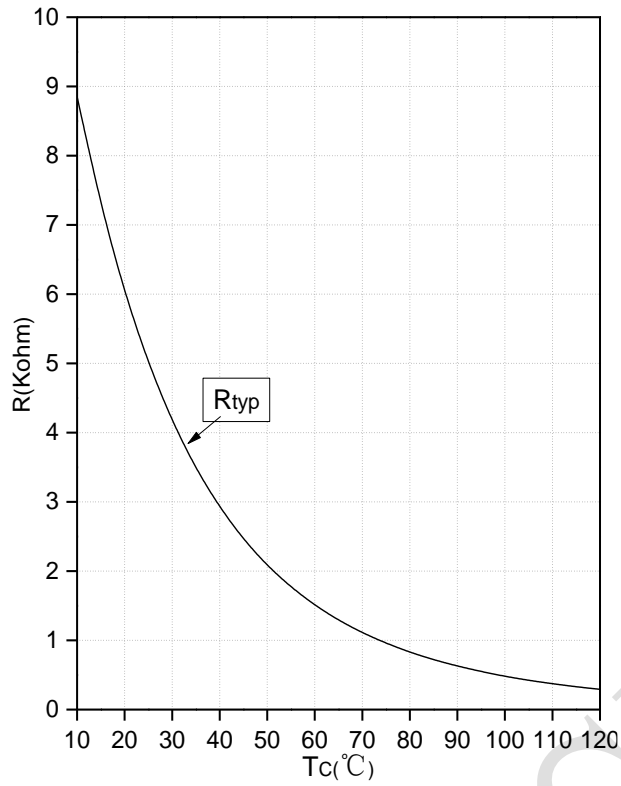
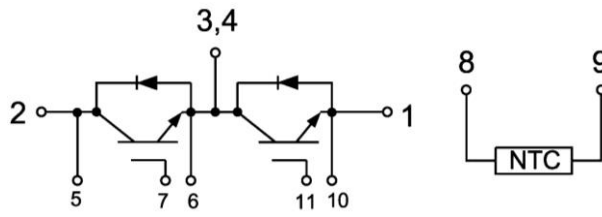


Fig.13 NTC Temperature Characteristics

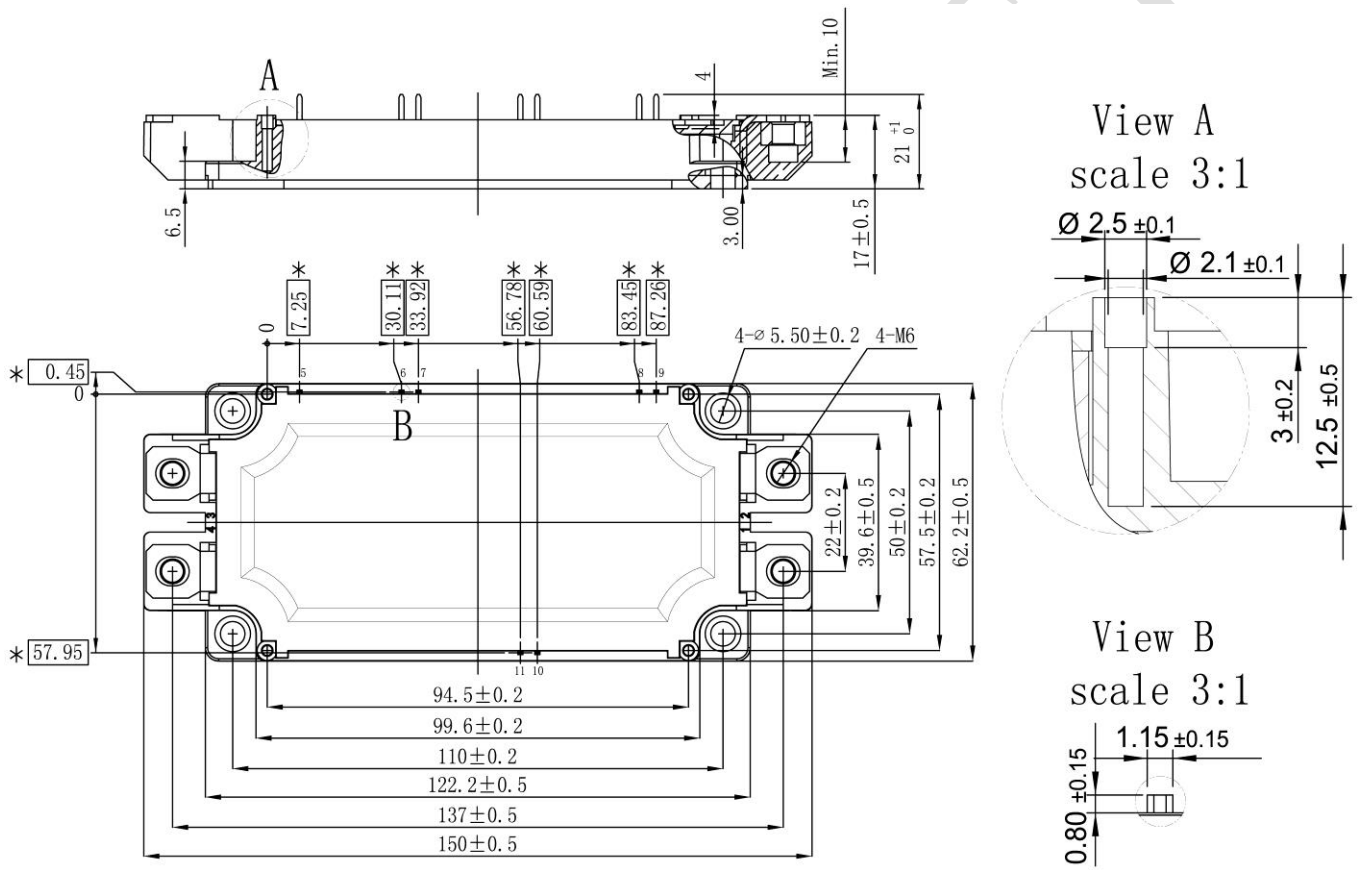
DATA SHEET



Internal Circuit:



Package Outline (Unit: mm):





Date	Revision	Notes
05/08/2019	A	Final Version
09/10/2021	B	Add " I_{sc} " Value
08/11/2022	C	Add " I^2 " Value
09/15/2022	D	Update Electrical Characteristics Value

Announcement

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